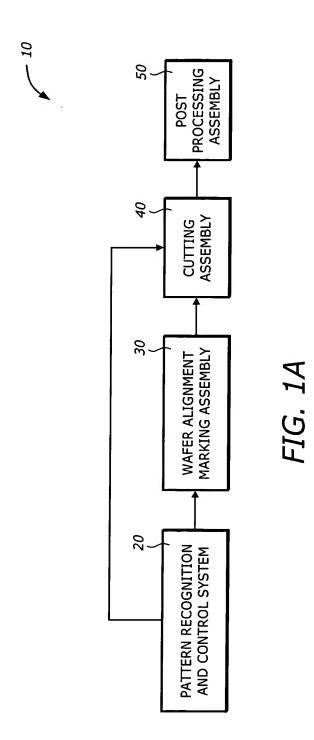
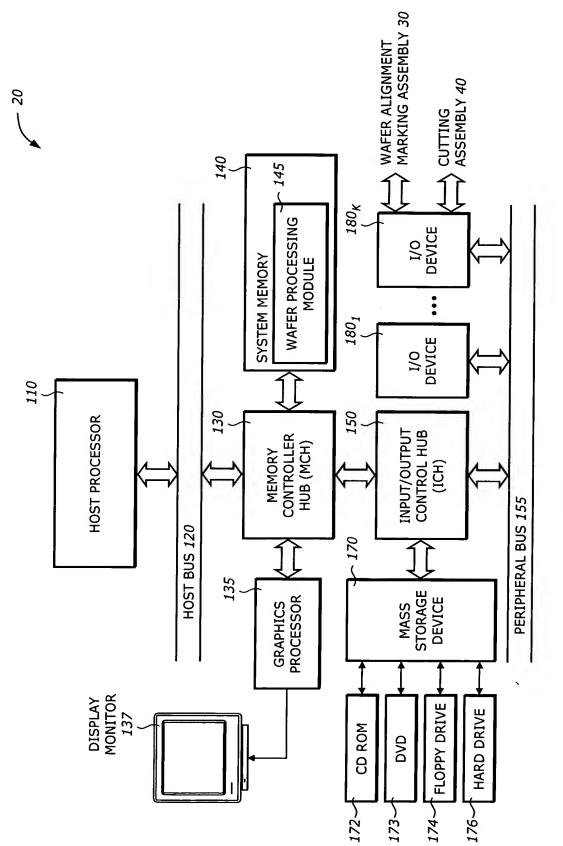
Blakely, Sokoloff, Taylor & Zafman LLP
Title: WAFER CUTTING USING LASER MARKING
1st Named Inventor: Lamberto V. Nepomuceno
Express Mail No.: EV323394009US

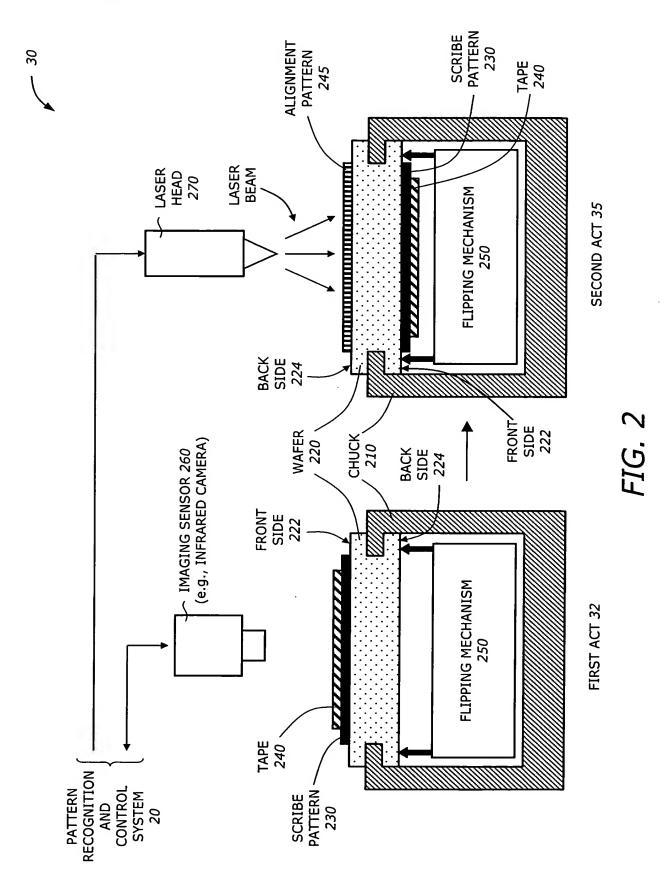
Sheet: 1 of 8



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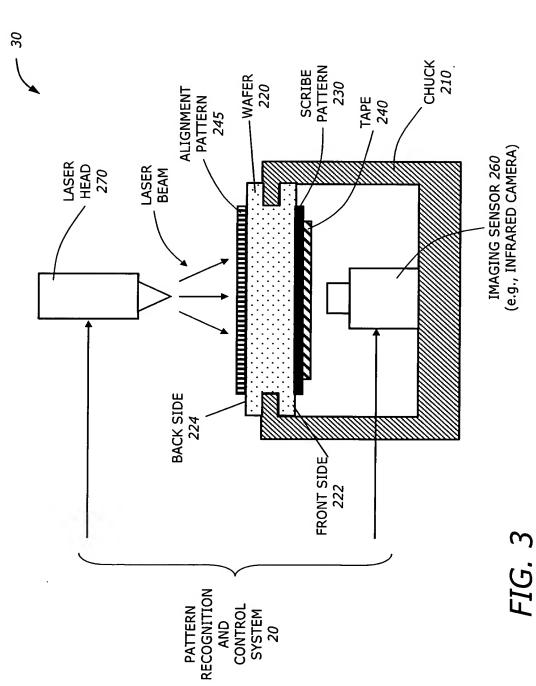


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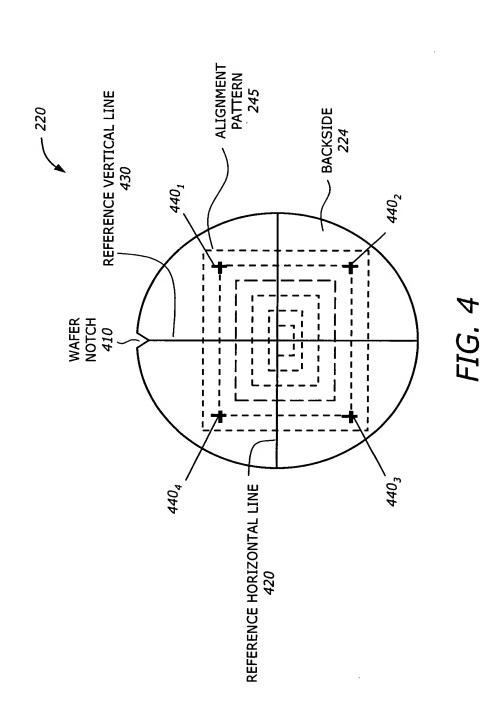


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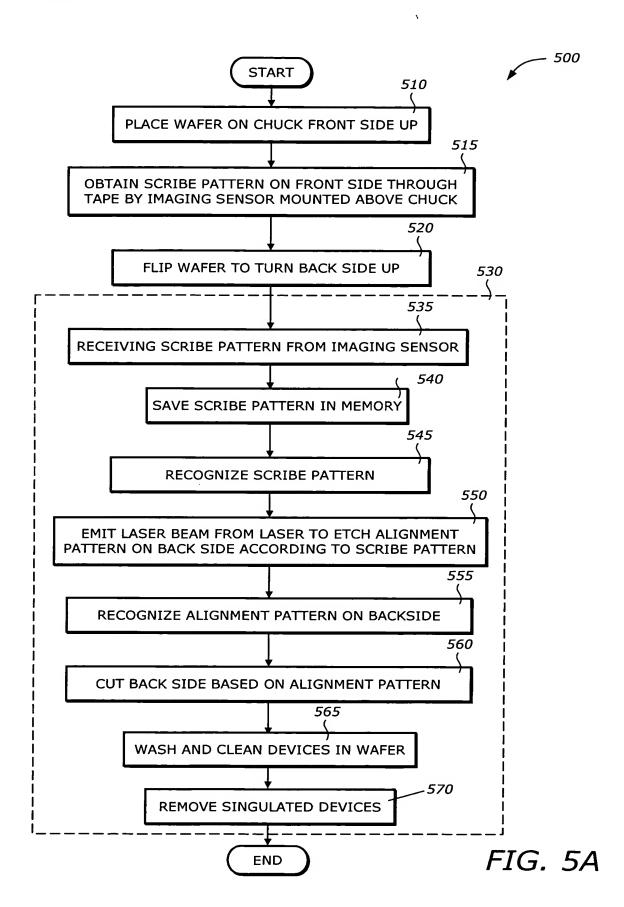
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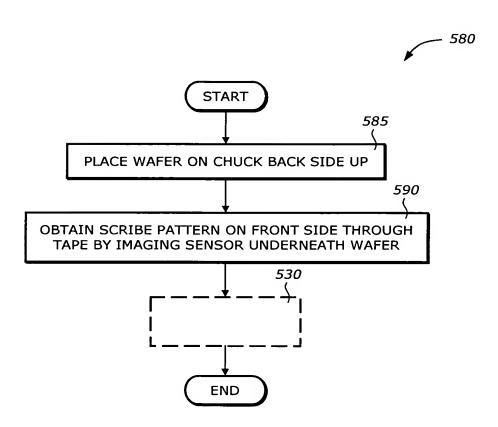


FIG. 5B

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